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## Spread-Spectrum EconOscillator

#### **General Description**

The DS1086 EconOscillator<sup>™</sup> is a programmable clock generator that produces a spread-spectrum (dithered) square-wave output of frequencies from 260kHz to 133MHz. The selectable dithered output reduces radiated-emission peaks by dithering the frequency 2% or 4% below the programmed frequency. The DS1086 has a power-down mode and an output-enable control for power-sensitive applications. All the device settings are stored in nonvolatile (NV) EEPROM memory allowing it to operate in stand-alone applications.

#### **Applications**

\_Features

- User-Programmable Square-Wave Generator
- Frequencies Programmable from 260kHz to 133MHz
- 2% or 4% Selectable Dithered Output
- Glitchless Output-Enable Control
- ♦ 2-Wire Serial Interface
- Nonvolatile Settings
- ♦ 5V Supply
- No External Timing Components Required
- Power-Down Mode
- 10kHz Master Frequency Step Size
- EMI Reduction

#### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
DS1086U	0°C to +70°C	8 µSOP
DS1086U+	0°C to +70°C	8 µSOP
DS1086Z	0°C to +70°C	8 SO
DS1086Z+	0°C to +70°C	8 SO

Note: Contact the factory for custom settings.

+Denotes a lead(Pb)-free/RoHS-compliant package.







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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

#### **ABSOLUTE MAXIMUM RATINGS**

Voltage on V <sub>CC</sub> Relative to Ground0.5V to +6.0V Voltage on SPRD, PDN, OE, SDA,
SCL Relative to Ground (See Note 1)0.5 to (V <sub>CC</sub> + 0.5V)
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )
µSOP (derate 4.5mW/°C above +70°C)
SO (derate 5.9mW/°C above +70°C)470.6mW

Note 1: This voltage must not exceed 6.0V.

Junction Temperature	+150°C
Operating Temperature Range	
Storage Temperature Range	55°C to +125°C
Soldering Temperature (reflow)	
Lead(Pb)-free	+260°C
Containing lead(Pb)	+240°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **RECOMMENDED DC OPERATING CONDITIONS**

 $(V_{CC} = 5V \pm 5\%, T_A = 0^{\circ}C \text{ to } + 70^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Supply Voltage	V <sub>CC</sub>	(Note 1)	4.75	5.00	5.25	V
High-Level Input Voltage (SDA, SCL)	VIH		0.7 x V <sub>CC</sub>		V <sub>CC</sub> + 0.3	V
Low-Level Input Voltage (SDA, SCL)	VIL		-0.3		0.3 x V <sub>CC</sub>	V
High-Level Input Voltage (SPRD, PDN, OE)	VIH		2		V <sub>CC</sub> + 0.3	V
Low-Level Input Voltage (SPRD, PDN, OE)	VIL		-0.3		0.8	V

#### DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 5V \pm 5\%, T_A = 0^{\circ}C \text{ to } + 70^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
High-Level Output Voltage (OUT)	VOH	$I_{OH} = -4mA$ , $V_{CC} = min$	2.4			V
Low-Level Output Voltage (OUT)	Vol	$I_{OL} = 4mA$			0.4	V
High-Level Input Current	IIН	$V_{CC} = 5.25V$			1	μΑ
Low-Level Input Current	١ <sub>IL</sub>	$V_{IL} = OV$	-1			μA
Supply Current (Active)	Icc	C <sub>L</sub> = 15pF (output at default frequency)			35	mA
Standby Current (Power-Down)	lccq	Power-down mode			35	μA

#### MASTER OSCILLATOR CHARACTERISTICS

#### $(V_{CC} = 5V \pm 5\%, T_A = 0^{\circ}C \text{ to } + 70^{\circ}C.)$

PARAMETER	SYMBOL	CON	MIN	ТҮР	MAX	UNITS		
Master Oscillator Range	fosc	(Note 2)	66		133	MHz		
Default Master Oscillator Frequency	fo				97.1		MHz	
Master Oscillator Frequency	<u>Δfo</u>	$V_{CC} = 5V,$ $T_A = +25^{\circ}C$	Default frequency(f <sub>0</sub> )	-0.75		+0.75	%	
Tolerance	f <sub>O</sub>	(Notes 3,17)	DAC step size	-0.75		+0.75	70	
Voltage Frequency Variation	Δ <u>fv</u>	Over voltage range,	Default frequency	-0.75		+0.75	%	
voltage Frequency variation	fo	$T_A = +25^{\circ}C$ (Note 4)	DAC step size	-0.75		+0.75	%	
		Over temperature	Default frequency	-0.5		+0.5		
Temperature Frequency Variation	$\frac{\Delta f_T}{f_0}$	range, $V_{CC} = 5V$	133MHz	-0.5		+0.5	%	
	10	(Note 5)	66MHz	-1.0		+1.0		
Dither Frequency Denge	<u>Δf</u>	Prescaler bit $J0 = 1$ (Note 6)			2		%	
Dither Frequency Range	fo	Prescaler bit J0 = 0 (N		4		/0		
Integral Nonlinearity of Frequency DAC	INL	Entire range (Note 7)		-0.4		+0.4	%	
DAC Step Size		Δ between two conser (Note 8)	cutive DAC values		10		kHz	
DAC Span		Frequency range for o (see Table 2)	one offset setting		10.24		MHz	
DAC Default		Factory default registe	er setting		500		decimal	
Offset Step Size		$\Delta$ between two consecutive offset values (see Table 2)			5.12		MHz	
Offset Default	OS	Factory default OFFSET register setting (5 LSBs) (see Table 2)		RANGE (5 LSBs of RANGE register)		of	hex	
Dither Rate					f <sub>0</sub> /4096	3	Hz	

#### AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 5V \pm 5\%, T_A = 0^{\circ}C \text{ to } + 70^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
Frequency Stable After Prescaler Change					1	Period
Frequency Stable After DAC or Offset Change		(Note 9)		0.2	1	ms
Power-Up Time	t <sub>por</sub> + t <sub>stab</sub>	(Note 10)		0.1	0.5	ms
Enable of OUT After Exiting Power-Down Mode	t <sub>stab</sub>				500	μs
OUT High-Z After Entering Power-Down Mode	t <sub>pdn</sub>				0.1	ms
Load Capacitance	CL	(Note 11)		15	50	pF
Output Duty Cycle (OUT)			40		60	%
PDN Rise/Fall Time					1	μs

#### AC ELECTRICAL CHARACTERISTICS: 2-WIRE INTERFACE

 $(V_{CC} = 5V \pm 5\%, T_A = 0^{\circ}C \text{ to } + 70^{\circ}C.)$ 

PARAMETER	SYMBOL	CON	DITION	MIN	ТҮР	MAX	UNITS	
	facu	Fast mode	(Note 12)			400	kHz	
SCL Clock Frequency	fscl	Standard mode	(INDLE IZ)			100	КПД	
Bus Free Time Between a STOP	taura	Fast mode	(Noto 12)	1.3				
and START Condition	<sup>t</sup> BUF	Standard mode	(Note 12)	4.7			μs	
Hold Time (Repeated) START	tup 074	Fast mode	(Neteo 12, 12)	0.6				
Condition	<sup>t</sup> hd:sta	Standard mode	(Notes 12, 13)	4.0			μs	
LOW Period of SCL	ti our	Fast mode	(Noto 12)	1.3				
	tlow	Standard mode	(Note 12)	4.7			μs	
HIGH Period of SCL	tunou	Fast mode	(Note 12)	0.6				
	thigh	Standard mode	(Note 12)	4.0			μs	
Setup Time for a Repeated	to o	Fast mode	(Nete 12)	0.6				
START	tsu:sta	Standard mode	(Note 12)	4.7			μs	
Data Hald Times		Fast mode	(Natao 10, 14, 15)	0		0.0		
Data Hold Time	<sup>t</sup> HD:DAT	Standard mode	(Notes 12, 14, 15)	0		0.9	μs	
Data Catura Tima		Fast mode	(Note 10)	100				
Data Setup Time	tsu:dat	Standard mode	(Note 12)	250			ns	
Rise Time of Both SDA and SCL	<b>1</b>	Fast mode	(Nete 1C)	20 + 0.10	Св	300		
Signals	tR	Standard mode	(Note 16)	20 + 0.10	Св	1000	ns	
Fall Time of Both SDA and SCL	+	Fast mode	(Nete 10)	20 + 0.10	Св	300	ns	
Signals	tF	Standard mode	(Note 16)	20 + 0.10	Св	1000		

#### AC ELECTRICAL CHARACTERISTICS: 2-WIRE INTERFACE (continued)

 $(V_{CC} = 5V \pm 5\%, T_A = 0^{\circ}C \text{ to } + 70^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITION	MIN	ТҮР	MAX	UNITS
Setup Time for STOP	toulotto	Fast mode	0.6			110
	tsu:sto	Standard mode	4.0			μs
Capacitive Load for Each Bus Line	Св	(Note 16)			400	pF
NV Write-Cycle Time	t <sub>WR</sub>				10	ms
Input Capacitance	CI			5		рF

**Note 1:** All voltages are referenced to ground.

- **Note 2:** DAC and OFFSET register settings must be configured to maintain the master oscillator frequency within this range. Correct operation of the device is not guaranteed if these limits are exceeded.
- Note 3: This is the absolute accuracy of the master oscillator frequency at the default settings.
- **Note 4:** This is the change that is observed in master oscillator frequency with changes in voltage from nominal voltage at  $T_A = +25^{\circ}C$ .
- **Note 5:** This is the percentage frequency change from the +25°C frequency due to temperature at V<sub>CC</sub> = 5V. The maximum temperature change varies with the master oscillator frequency setting. The minimum occurs at the default master oscillator frequency (f<sub>default</sub>). The maximum occurs at the extremes of the master oscillator frequency range (66MHz or 133MHz) (see Figure 2).
- Note 6: The dither deviation of the master oscillator frequency is unidirectional and lower than the undithered frequency.
- **Note 7:** The integral nonlinearity of the frequency adjust DAC is a measure of the deviation from a straight line drawn between the two endpoints of a range. The error is in percentage of the span.
- **Note 8:** This is true when the prescaler = 1.
- **Note 9:** Frequency settles faster for small changes in value. During a change, the frequency transitions smoothly from the original value to the new value.
- **Note 10:** This indicates the time elapsed between power-up and the output becoming active. An on-chip delay is intentionally introduced to allow the oscillator to stabilize. t<sub>stab</sub> is equivalent to approximately 512 master clock cycles and therefore depends on the programmed clock frequency.
- Note 11: Output voltage swings can be impaired at high frequencies combined with high output loading.
- **Note 12:** A fast-mode device can be used in a standard-mode system, but the requirement  $t_{SU:DAT} > 250$ ns must then be met. This is automatically the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line at least  $t_{R,MAX} + t_{SU:DAT} = 1000$ ns + 250ns = 1250ns before the SCL line is released.
- **Note 13:** After this period, the first clock pulse is generated.
- **Note 14:** A device must internally provide a hold time of at least 300ns for the SDA signal (referred to as the V<sub>IH MIN</sub> of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.
- Note 15: The maximum t<sub>HD:DAT</sub> need only be met if the device does not stretch the LOW period (t<sub>LOW</sub>) of the SCL signal.
- Note 16:  $C_B$ —total capacitance of one bus line, timing referenced to 0.9 x V<sub>CC</sub> and 0.1 x V<sub>CC</sub>.
- Note 17: Typical frequency shift due to aging is ±0.5%. Aging stressing includes Level 1 moisture reflow preconditioning (24hr +125°C bake, 168hr 85°C/85%RH moisture soak, and 3 solder reflow passes +240 +0/-5°C peak) followed by 1000hr max V<sub>CC</sub> biased 125°C HTOL, 1000 temperature cycles at -55°C to +125°C, 96hr 130°C/85%RH/5.5V HAST and 168hr 121°C/2 ATM Steam/Unbiased Autoclave.

VOLTAGE (V)



**Typical Operating Characteristics** 

TEMPERATURE (°C)

**DS1086** 

#### Pin Description

PIN	NAME	FUNCTION
1	OUT	Oscillator Output
2	SPRD	Dither Enable. When the pin is high, the dither is enabled. When the pin is low, the dither is disabled.
3	V <sub>CC</sub>	Power Supply
4	GND	Ground
5	OE	Output Enable. When the pin is high, the output buffer is enabled. When the pin is low, the output is disabled but the master oscillator is still on.
6	PDN	Power-Down. When the pin is high, the master oscillator is enabled. When the pin is low, the master oscillator is disabled (power-down mode).
7	SDA	2-Wire Serial Data. This pin is for serial data transfer to and from the device. The pin is open drain and can be wire-OR'ed with other open-drain or open-collector interfaces.
8	SCL	2-Wire Serial Clock. This pin is used to clock data into the device on rising edges and clock data out on falling edges.







**Processor-Controlled Mode** 





Figure 2. Temperature Variation Over Frequency

#### Stand-Alone Mode



REGISTER	ADDR	MSB			BIN	ARY			LSB	FACTORY DEFAULT	ACCESS
PRESCALER	02h	X1	X <sub>1</sub>	XX	JO	P3	P2	P1	P0	11100000b	R/W
DAC HIGH	08h	b9	b8	b7	b6	b5	b4	b3	b2	01111101b	R/W
DAC LOW	09h	b1	b0	X <sub>0</sub>	0000000b	R/W					
OFFSET	0Eh	X1	X1	X1	b4	b3	b2	b1	b0	111b	R/W
ADDR	0Dh	X1	X1	X1	X1	WC	A2	A1	AO	11110000b	R/W
RANGE	37h	XX	XX	XX	b4	b3	b2	b1	b0	xxxb	R
WRITE EE	3Fh			NO DATA						—	_

#### **Table 1. Register Summary**

X<sub>0</sub> = Don't care, reads as zero.

 $X_1 = Don't care, reads as one.$ 

 $X_X = Don't$  care, reads indeterminate.

X = Don't care.

#### **Table 2. Offset Settings**

OFFSET	FREQUENCY RANGE (MHz)
OS - 6	61.44 to 71.67
OS - 5	66.56 to 76.79
OS - 4	71.68 to 81.91
OS - 3	76.80 to 87.03
OS - 2	81.92 to 92.15
OS - 1	87.04 to 97.27
OS*	92.16 to 102.39
OS + 1	97.28 to 107.51
OS + 2	102.40 to 112.63
OS + 3	107.52 to 117.75
OS + 4	112.64 to 122.87
OS + 5	117.76 to 127.99
OS + 6	122.88 to 133.11

\*Factory default setting. OS is the integer value of the 5 LSBs of the RANGE register.

#### **Detailed Description**

A block diagram of the DS1086 is shown in Figure 3. The internal master oscillator generates a square wave with a 66MHz to 133MHz frequency range. The frequency of the master oscillator can be programmed with the DAC register over a two-to-one range in 10kHz steps. The master oscillator range is larger than the range possible with the DAC step size, so the OFFSET register is used to select a smaller range of frequencies over which the DAC spans. The prescaler can then be set to divide the master oscillator frequency by 2<sup>x</sup> (where x equals 0 to 8) before routing the signal to the output (OUT) pin.

A programmable triangle-wave generator injects an offset element into the master oscillator to dither its output 2% or 4%. The dither is controlled by the J0 bit in the PRESCALER register and enabled with the SPRD pin. The maximum spectral attenuation occurs when the prescaler is set to 1. The spectral attenuation is reduced by 2.7dB for every factor of 2 that is used in the prescaler. This happens because the prescaler's divider function tends to average the dither in creating the lower frequency. However, the most stringent spectral emission limits are imposed on the higher frequencies where the prescaler is set to a low divider ratio.

The external control input, OE, gates the clock output buffer. The PDN pin disables the master oscillator and turns off the clock output for power-sensitive applications\*. On power-up, the clock output is disabled until power is stable and the master oscillator has generated 512 clock cycles. Both controls feature a synchronous enable that ensures there are no output glitches when the output is enabled, and a constant time interval (for a given frequency setting) from an enable signal to the first output transition.

The control registers are programmed through a 2-wire interface and are used to determine the output frequency and settings. Once programmed into EEPROM, since the register settings are NV, the settings only need to be reprogrammed if it is desired to reconfigure the device.

\*The power-down command must persist for at least two output frequency cycles plus 10µs for deglitching purposes.





Figure 3. DS1086 Block Diagram

The output frequency is determined by the following equation:

$$f_{OUTPUT} = \frac{(MIN FREQUENCY OF SELECTED OFFSET RANGE) + (DAC VALUE \times 10kHz STEP SIZE)}{PRESCALER}$$
(1)

where: *min frequency of selected OFFSET range* is the lowest frequency (shown in Table 2 for the corresponding offset).

DAC value is the value of the DAC register (0 to 1023).

*Prescaler* is the value of  $2^x$  where x = 0 to 8.

See the *Example Frequency Calculations* section for a more in-depth look at using the registers.

#### **Register Definitions**

The DS1086 registers are used to determine the output frequency and dither amount. A summary of the registers is shown in Table 1. Using the default register settings below, the default output frequency is 97.1MHz. See the *Example Frequency Calculations* section for an example on how to determine the register settings for a desired output frequency.

#### **PRESCALER** Register

The PRESCALER register controls the prescaler (bits P3 to P0) and dither (bit J0). The prescaler divides the master oscillator frequency by  $2^x$  where x can be from 0 to 8. Any prescaler value entered that is greater than 8 decodes as 8. The dither applied to the output is controlled with bit J0. When J0 is high, 2% peak dither is selected. When J0 is low, 4% peak dither is selected.

#### **DAC HIGH/DAC LOW Register**

The 2-byte DAC register sets the frequency of the master oscillator to a particular value within the current offset range. Each step of the DAC changes the master oscillator frequency by 10kHz. The first byte is the MSB (DAC HIGH) and the second byte is the LSB (DAC LOW).

#### **OFFSET** Register

The OFFSET register determines the range of frequencies that can be obtained for a given DAC setting. The factory default offset is copied into the RANGE register so the user can access the default offset after making changes to the OFFSET register. See Table 2 for OFFSET ranges.

Correct operation of the device is not guaranteed outside the range 66MHz to 133MHz.



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#### **ADDR Register**

The A0, A1, A2 bits determine the 2-wire slave address. The WC bit determines if the EEPROM is to be written to after register contents have been changed. If WC = 0 (default), EEPROM is written automatically after a WRITE EE command. If WC = 1, the EEPROM is only written when the WRITE EE command is issued. In applications where the register contents are frequently written, the WC bit should be set to 1. Otherwise, it is necessary to wait for an EEPROM write cycle to complete between writing to the registers. This also prevents wearing out the EEPROM. Regardless of the value of the WC bit, the value of the ADDR register is always written immediately to EEPROM. When the WRITE EE command has been received, the contents of the registers are written into the EEPROM, thus locking in the register settings.

**RANGE** Register

This read-only register contains a copy of the factoryset offset (OS). This value can be read to determine the default value of the OFFSET register when programming a new master oscillator frequency.

#### WRITE EE Command

This command is used to write data from RAM to EEPROM when the WC bit in ADDR register is 1. See the *ADDR Register* section for more details.

#### **Example Frequency Calculations**

**Example #1:** Calculate the register values needed to generate a desired output frequency of 11.0592MHz. Since the desired frequency is not within the valid master oscillator range of 66MHz to 133MHz, the prescaler must be used. Valid prescaler values are 2<sup>x</sup> where x equals 0 to 8 (and x is the value that is programmed into the P3 to P0 bits of the PRESCALER register). Equation 1 shows the relationship between the desired frequency, the master oscillator frequency, and the prescaler.

$$f_{\text{DESIRED}} = \frac{f_{\text{MASTER OSCILLATOR}}}{\text{prescaler}} = \frac{f_{\text{MASTER OSCILLATOR}}}{2^{X}}$$
(2)

By trial and error, x is incremented from 0 to 8 in Equation 2, finding values of x that yield master oscillator frequencies within the range of 66MHz to 133MHz.

Equation 2 shows that a prescaler of 8 (x = 3) and a master oscillator frequency of 88.4736MHz generates our desired frequency. In terms of the device register, x = 3 is programmed in the lower four bits of the PRESCALER register. Writing 03h to the PRESCALER register sets the PRESCALER to 8 (and 4% peak dither). Be aware that the J0 bit also resides in the PRESCALER register.

fMASTER OSCILLATOR = fDESIRED x prescaler = fDESIRED x  $2^{X}$ 

fMASTER OSCILLATOR = 11.0592MHz x 2<sup>3</sup> = 88.4736MHz (3)

Once the target master oscillator frequency has been calculated, the value of offset can be determined. Using Table 2, 88.4736MHz falls within both OS - 1 and OS - 2. However, choosing OS - 1 would be a poor choice since 88.4736MHz is so close to OS - 1's minimum frequency. On the other hand, OS - 2 is ideal since 88.4736MHz is very close to the center of OS - 2's frequency span. Before the OFFSET register can be programmed, the default value of offset (OS)



Figure 4. 2-Wire Data Transfer Protocol

must be read from the RANGE register (last five bits). In this example. 12h (18 decimal) was read from the RANGE register. OS - 2 for this case is 10h (16 decimal). This is the value that is written to the OFFSET register.

Finally, the two-byte DAC value needs to be determined. Since OS - 2 only sets the range of frequencies, the DAC selects one frequency within that range as shown in Equation 3.

#### **MASTER OSCILLATOR = (MIN FREQUENCY OF SELECTED OFFSET** RANGE) + (DAC value x 10kHz)

Valid values of DAC are 0 to 1023 (decimal) and 10kHz is the step size. Equation 4 is derived from rearranging Equation 3 and solving for DAC.

$$DAC VALUE = \frac{(88.4736MHz - 81.92MHz)}{10kHz STEP SIZE}$$

$$DAC VALUE = \frac{(88.4736MHz - 81.92MHz)}{10kHz STEP SIZE} (4)$$

Since the two-byte DAC register is left justified, 655 is converted to hex (028Fh) and bit-wise shifted left six places. The value to be programmed into the DAC register is A3C0h.

In summary, the DS1086 is programmed as follows:

PRESCALER = 03h (4% peak dither) or 13h (2% peak dither)

OFFSET = OS - 2 or 10h (if range was read as 12h)

$$DAC = A3C0h$$

Notice that the DAC value was rounded. Unfortunately, this means that some error is introduced. In order to calculate how much error, a combination of Equation 1 and Equation 3 is used to calculate the expected output frequency. See Equation 5.

$$f_{OUTPUT} = \frac{\frac{\text{MIN FREQUENCY OF SELECTED OFFSET}}{\text{prescaler}}}{\text{foutput}} = \frac{\frac{(81.92\text{MHz}) + (\text{bAC VALUE x 10\text{kHz STEP SIZE})}{\text{prescaler}}}{8} = \frac{(81.92\text{MHz}) + (655 \times 10\text{kHz})}{8} = \frac{\frac{88.47\text{MHz}}{8}}{8} = 11.05875\text{MHz}}$$
(5)

The expected output frequency is not exactly equal to the desired frequency of 11.0592MHz. The difference is 450Hz. In terms of percentage, Equation 6 shows that the expected error is 0.004%. The expected error assumes typical values and does not include deviations from the typical as specified in the electrical tables.

$$%ERROR_{EXPECTED} = \frac{\text{f}_{DESIRED} - \text{f}_{EXPECTED} \times 100}{\text{f}_{DESIRED}}$$
(6)  
$$%ERROR_{EXPECTED} = \frac{11.0592MHz - 11.05875MHz}{11.0592MHz}$$
$$\times 100 = -\frac{450Hz}{2} \times 100 = 0.004\%$$

 $\times 100 = \frac{450H2}{11.0592MHz} \times 100 = 0.004\%$ 

#### Example #2: Calculate the register values needed to generate a desired output frequency of 100MHz.

Since the desired frequency is already within the valid master oscillator frequency range, the prescaler is set to divide by 1, and hence, PRESCALER = 00h (for 4% peak dither) or 10h (for 2% peak dither). (7)

fMASTER OSCILLATOR = 100.0MHz x 2<sup>0</sup> = 100.0MHz

Next, looking at Table 2, OS + 1 provides a range of frequencies centered around the desired frequency. In order to determine what value to write to the OFFSET register, the RANGE register must first be read. Assuming 12h was read in this example, 13h(OS + 1)is written to the OFFSET register.

Finally, the DAC value is calculated as shown in Equation 8. (8)

DAC VALUE = 
$$\frac{(100.0MHz - 97.28MHz)}{10kHz STEP SIZE}$$
 = 272.00 (decimal)

The result is then converted to hex (0110h) and then left-shifted, resulting in 4400h to be programmed into the DAC register.

In summary, the DS1086 is programmed as follows:

PRESCALER = 00h (4% peak dither) or 10h (2% peak dither)

OFFSET = OS + 1 or 13h (if RANGE was read as 12h)DAC = 4400h

$$f_{OUTPUT} = \frac{(97.28MHz) + (272 \times 10kHz)}{2^{0}} = \frac{100.0MHz}{1} = 100.0MHz$$

(9)





Figure 6. 2-Wire AC Characteristics

Since the expected output frequency is equal to the desired frequency, the calculated error is 0%.

#### **2-Wire Serial Port Operation**

#### **2-WIRE SERIAL DATA BUS**

The DS1086 communicates through a 2-wire serial interface. A device that sends data onto the bus is defined as a transmitter, and a device receiving data as a receiver. The device that controls the message is called a "master." The devices that are controlled by the master are "slaves." A master device that generates the serial clock (SCL), controls the bus access, and generates the START and STOP conditions must control the bus. The DS1086 operates as a slave on the 2-wire bus. Connections to the bus are made through the open-drain I/O lines SDA and SCL.

The following bus protocol has been defined (see Figures 4 and 6):

• Data transfer can be initiated only when the bus is not busy.

• During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is high are interpreted as control signals.

Accordingly, the following bus conditions have been defined:

Bus not busy: Both data and clock lines remain HIGH.

**Start data transfer:** A change in the state of the data line, from HIGH to LOW, while the clock is HIGH, defines a START condition.

**Stop data transfer:** A change in the state of the data line, from LOW to HIGH, while the clock line is HIGH, defines the STOP condition.

**Data valid:** The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal. The data on the line must be changed during the LOW period of the clock signal. There is one clock pulse per bit of data.



Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of data bytes transferred between START and STOP conditions is not limited, and is determined by the master device. The information is transferred byte-wise and each receiver acknowledges with a ninth bit.

Within the bus specifications a regular mode (100kHz clock rate) and a fast mode (400kHz clock rate) are defined. The DS1086 works in both modes.

**Acknowledge:** Each receiving device, when addressed, is obliged to generate an acknowledge after the byte has been received. The master device must generate an extra clock pulse that is associated with this acknowledge bit.

A device that acknowledges must pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge-related clock pulse. Of course, setup and hold times must be taken into account. When the DS1086 EEPROM is being written to, it is not able to perform additional responses. In this case, the slave DS1086 sends a not acknowledge to any data transfer request made by the master. It resumes normal operation when the EEPROM operation is complete.

A master must signal an end of data to the slave by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave must leave the data line HIGH to enable the master to generate the STOP condition.

Figures 4, 5, 6, and 7 detail how data transfer is accomplished on the 2-wire bus. Depending upon the state of the R/W bit, two types of data transfer are possible:

- Data transfer from a master transmitter to a slave receiver. The first byte transmitted by the master is the slave address. Next follows a number of data bytes. The slave returns an acknowledge bit after each received byte.
- 2) Data transfer from a slave transmitter to a master receiver. The first byte (the slave address) is transmitted by the master. The slave then returns an acknowledge bit. Next follows a number of data bytes transmitted by the slave to the master. The master returns an acknowledge bit after all received bytes other than the last byte. At the end of the last received byte, a not acknowledge is returned.

The master device generates all of the serial clock pulses and the START and STOP conditions. A transfer is ended with a STOP condition or with a repeated START condition. Since a repeated START condition is also the beginning of the next serial transfer, the bus is not released.

The DS1086 can operate in the following two modes:

**Slave receiver mode:** Serial data and clock are received through SDA and SCL. After each byte is received, an acknowledge bit is transmitted. START and STOP conditions are recognized as the beginning and end of a serial transfer. Address recognition is performed by hardware after reception of the slave address and direction bit.

**Slave transmitter mode:** The first byte is received and handled as in the slave receiver mode. However, in this mode, the direction bit indicates that the transfer direction is reversed. Serial data is transmitted on SDA by the DS1086 while the serial clock is input on SCL. START and STOP conditions are recognized as the beginning and end of a serial transfer.

#### **Slave Address**

Figure 5 shows the first byte sent to the device. It includes the device identifier, device address, and the R/W bit. The device address is determined by the ADDR register.

#### **Registers/Commands**

See Table 1 for the complete list of registers/commands and Figure 7 for an example of using them.

#### **Applications Information**

#### **Power-Supply Decoupling**

To achieve the best results when using the DS1086, decouple the power supply with  $0.01\mu$ F and  $0.1\mu$ F high-quality, ceramic, surface-mount capacitors. Surface-mount components minimize lead inductance, which improves performance, and ceramic capacitors tend to have adequate high-frequency response for decoupling applications. These capacitors should be placed as close to pins 3 and 4 as possible.

#### **Stand-Alone Mode**

SCL and SDA cannot be left floating when they are not used. If the DS1086 never needs to be programmed incircuit, including during production testing, SDA and SCL can be tied high. The SPRD pin must be tied either high or low.



Figure 7. 2-Wire Transactions

#### **Chip Information**

SUBSTRATE CONNECTED TO GROUND

#### **Package Information**

For the latest package outline information and land patterns (footprints), go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
8 µSOP	U8-1	<u>21-0036</u>	<u>90-0092</u>
8 SO	S8-4	<u>21-0041</u>	<u>90-0096</u>

#### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/02	Initial release	—
1	9/03	Corrected the dither rate in the <i>Master Oscillator Characteristics</i> table; updated Table 2	3, 8
2	3/12	Updated the Ordering Information, Absolute Maximum Ratings, and Package Information	1, 2, 14

# DS1086

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